



NOTE: ⑭

1. FINISH: SILVER PLATE.
.000050-.000100 SILVER OVER
.000100 COPPER

2.08.12	PLATING WAS .300μ – .500μ CHANGE AS PER ECN 12–014	D	.000100 COPPER			
10.29.02	ECN 02–071 ④ WAS ±.005, ③ ADD DIMENSIONS FOR DETAIL, ADD PLATING SPECIFICATION	C	KEYSTONE ELECTRONICS CORP. ASTORIA, N.Y. 11105-2017			
			PART NAME CONTACT PIN			
			MATERIAL ⑬ BRASS			
11.17.00	ECN 00–115 MAT'L WAS BERYLLIUM COPPER	B	FINISH AS NOTED		DRN BY BOONE	DATE 11.27.89
7.18.94	ECR 94–022 ① WAS .250, ② WAS .130	A	TOLERANCES INCH [MM] DECIMAL ± .005 [±] ANGULAR ± 1°		APP'D LN	SCALE 6X
			UNLESS OTHERWISE SPECIFIED		DWG NO. F-6036-1	
DATE	DESCRIPTION	REV.				